

# OFET TEST BOARDS USER MANUAL

Manual version: 1.0.C

Product code: P2013/P2014

**Product Version:** 1.0

#### **Contents**

1.	O,	Overview		
2.	El	J Declaration of Conformity	4	
3.	Sa	afety	7	
	3.1	Warning	7	
	3.2	Use of Equipment	7	
	3.3	Hazard Icons		
	3.4	General Hazards		
	3.5	Servicing	8	
	3.6	Health and Safety – Servicing	8	
4.	0	peration	9	
	4.1	Low Density OFET Test Board		
	4.2	OFET Test Board for High Density OFETs	. 10	
5.	М	leasurement Error and Noise	.12	
	5.1	High Accuracy Measurements	. 12	
	5.2	Factors Affecting Measurement Accuracy	. 13	
	5.3	Test set-up conditions	. 17	
6.	Re	Related Products1		

#### 1. Overview

The Ossila OFET Test Boards are designed to work with our pre-patterned OFET substrates, prefabricated OFET test chips, and devices fabricated using Ossila's OFET evaporation masks, eliminating the need for probe stations and simplifying the measurement of OFET devices.





## 2. EU Declaration of Conformity

#### We

Company Name: Ossila BV

Postal Address: Biopartner 3 building, Galileiweg 8

**Postcode:** 2333 BD Leiden **Country:** The Netherlands

Telephone number: +31 (0)71 3322992

Email Address: info@ossila.com

# declare that the DoC is issued under our sole responsibility and belongs to the following product:

Product: Low Density OFET Test Board (P2013A1), OFET Test Board for High Density OFETs

(P2014A1)

Serial number: E222-xxxx, E481-xxxx, P2013A1-xxxx, P2014A1-xxxx

#### Object of declaration:

Low Density OFET Test Board (E222, P2013A1)
OFET Test Board for High Density OFETs (E481, P2014A1)

# The object of declaration described above is in conformity with the relevant Union harmonisation legislation:

EMC Directive 2014/30/EU RoHS Directive 2011/65/EU

Signed:



Name: Dr James Kingsley

Place: Leiden
Date: 16/11/2021

Декларация за съответствие на ЕС

Производител: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Декларира с цялата си отговорност, че посоченото оборудване съответства на приложимото законодателство на EC за хармонизиране, посочено на предходната(-ите) страница(-и) на настоящия документ.

[Čeština] Prohlášení o shodě EU

Výrobce: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Prohlašujeme na vlastní odpovědnost, že uvedené zařízeni je v souladu s příslušnými harmonizačními předpisy EU uvedenými na předchozích stranách tohoto dokumentu.

[Dansk] EU-overensstemme lseserklærin g

Producent: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Erklærer herved, at vi alene er ansvarlige for, at det nævnte udstyr er i overensstemmelse med den relevante EU-harmoniseringslovgivning, der er anført på den/de foregående side(r) i dette dokument.

[Deutsch] EU-Konformitätserklärung

Hersteller: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Wir erklären in alleiniger Verantwortung, dass das aufgeführte Gerät konform mit der relevanten EU-Harmonisierungsgesetzgebung auf den vorangegangenen Seiten dieses Dokuments ist.

[Eesti keel] ELi vastavusavaldus

Tootja: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Kinnitame oma ainuvastutusel, et loetletud seadmed on kooskõlas antud dokumendi eelmisel lehelküljel / eelmistel lehekülgedel ära toodud asjaomaste ELi ühtlustamise õigusaktidega.

[Ελληνικά] Δήλωση πιστότητας ΕΕ

Κατασκευαστής: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Δηλώνουμε υπεύθυνα όn ο αναφερόμενος εξοπλισμός συμμορφώνεται με τη σχεηκή νομοθεσία εναρμόνισης της ΕΕ που υπάρχει σης προηγούμενες σελίδες του παρόντος εγγράφου.

[Español] Declaración de conformidad UE

Fabricante: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Declaramos bajo nuestra única responsabilidad que el siguiente producto se ajusta a la pertinente legislación de armonización de la UE enumerada en las páginas anteriores de este documento.

[Français] Déclaration de conformité UE

Fabricant: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Déclarons sous notre seule responsabilité que le matériel mentionné est conforme à la législation en vigueur de l'UE présentée sur la/les page(s) précédente(s) de ce document.

[Hrvatski] E.U izjava o sukladnosti

Proizvođač: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Izjavljujemo na vlastitu odgovornost da je navedena oprema sukladna s mjerodavnim zakonodavstvom EU-a o usklađivanju koje je navedeno na prethodnoj(nim) stranici(ama) ovoga dokumenta.

[Italiano] Dichiarazione di conformità UE

Produttore: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Si dichiara sotto la propria personale responsabilità che l'apparecchiatura in elenco è conforme alla normativa di armonizzazione UE rilevante indicata nelle pagine precedenti del presente documento.

[Latviešu] ES atbils tības deklarācija

Ražotājs: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Ar pilnu atbilclību paziņojam, ka uzskaitītais aprīkojums atbilst attiecīgajiem ES saskaņošanas tiesību aktiem, kas minēti iepriekšējās šī dokumenta lapās.

[Lietuvių k.] ES atitikties deklaracija

Gamintojas: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL,

atsakingai pareiškia, kad išvardinta įranga atitinka aktualius ES harmonizavimo teisės aktus, nurodytus ankstesniuose šio dokumento

[Magyar] EU-s megfelelőségi nyilatkozat

Gyártó: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Kizárólagos felelősségünk mellett kijelentjük, hogy a felsorolt eszköz megfelel az ezen dokumentum előző oldalán/oldalain található EU-s összehangolt jogszabályok vonatkozó rendelkezéseinek.

[Nederlands] EU-Conformiteitsverklaring

Fabrikant: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Verklaart onder onze uitsluitende verantwoordelijkheid dat de vermelde apparatuur in overeenstemming is met de relevante harmonisatiewetgeving van de EU op de vorige pagina('s) van dit document.

[Norsk] EU-samsvarserklæ ring

Produsent: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Erklærer under vårt eneansvar at utstyret oppført er i overholdelse med relevant EU-harmoniseringslavverk som står på de(n) forrige siden(e) i dette dokumentet.

[Polski] Deklaracja zgodności Unii Europejskiej

Producent: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Oświadczamy na własną odpowiedzialność, że podane urządzenie jest zgodne ze stosownymi przepisami harmonizacyjnymi Unii Europejskiej, które przedstawiono na poprzednich stronach niniejszego dokumentu.

[Por tuguês] Declaração de Conformidade UE

Fabricante: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Declara sob sua exclusiva responsabilidade que o equipamento indicado está em conformidade com a legislação de harmonização relevante da UE mencionada na(s) página(s) anterior(es) deste documento.

[Română] Declarație de conformitate UE

Producător: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Declară pe proprie răspundere că echipamentul prezentat este în conformitate cu prevederile legislației UE de armonizare aplicabile prezentate la pagina/paginile anterioare a/ale acestui document.

[Slovensky] Vyhlásenie o zhode pre EÚ

Výrobca: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Na vlastnú zodpovednosť prehlasuje, že uvedené zariadenie je v súlade s príslušnými právnymi predpismi EÚ o harmonizácii uvedenými na predchádzajúcich stranách tohto dokumentu.

[Slovenščina] Izjava EU o skladnosti

Proizvajalec: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

s polno odgovornostjo izjavlja, da je navedena oprema skladna z veljavno uskladitveno zakonodajo EU, navedeno na prejšnji strani/prejšnjih straneh tega dokumenta.

[Suomi] EU-vaatimustenm ukaisuusvakuutus

Valmistaja: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Vakuutamme täten olevamme yksin vastuussa siitä, että tässä asiakirjassa luetellut laitteet ovat tämän asiakirjan sivuilla edellisillä sivuilla kuvattujen olennaisten yhdenmukaistamista koskevien EU-säädösten vaatimusten mukaisia.

[Svenska] EU-försäkran om överensstämmelse

Tillverkare: Ossila BV, Biopartner 3 building, Galileiweg 8, 2333 BD Leiden, NL.

Vi intygar härmed att den utrustning som förtecknas överensstämmer med relevanta förordningar gällande EUharmonisering som fmns på föregående sidor i detta dokument.

www.ossila.com 6 Ossila Limited © 2023

## 3. Safety

#### 3.1 Warning

• When using the test board without an interlocked electrical test cage or enclosure the maximum operating voltage is ±50 VAC and ±70 VDC.

- When using the test board with an interlocked electrical test cage or enclosure the absolute maximum operating voltage is ±100 V and the absolute maximum operating current is ±100 mA.
- Do NOT touch the test board or operate the switches while voltage or current is applied to the test board.

#### 3.2 Use of Equipment

The Ossila OFET Test Boards are designed to be used as instructed. They are intended for use under the following conditions:

- Indoors in a laboratory environment (Pollution Degree 2)
- Altitudes up to 2000m
- Temperatures of 5°C to 40°C; maximum relative humidity of 80% up to 31°C.

#### 3.3 Hazard Icons

The following symbols can be found at points throughout the rest of the manual. Note and read each warning before attempting any associated operations associated with it:

 Table 3.1. Hazard warning labels used in this manual.

Symbol	Associated Hazard
4	Electrical shock

#### 3.4 General Hazards

Before installing or operating the Ossila OFET Test Boards there are several health and safety precautions which must be followed and executed to ensure safe installation and operation.

#### 3.5 Servicing

If servicing is required, please return the unit to Ossila Ltd. The warranty will be invalidated if:

- Modification or service has been carried out by anyone other than an Ossila engineer.
- The Unit has been subjected to chemical damage through improper use.
- The Unit has been operated outside the usage parameters stated in the user documentation associated with the Unit.
- The Unit has been rendered inoperable through accident, misuse, contamination, improper maintenance, modification, or other external causes.

#### 3.6 Health and Safety - Servicing



Servicing should only be performed by an Ossila engineer. Any modification or alteration may damage the equipment, cause injury, or death. It will also void your equipment's warranty.

## 4. Operation

Test boards should be secured to prevent them from moving during measurement, ideally away from sources of electromagnetic or electrostatic noise.

If you are performing a measurement greater than ±50 VAC or ±70 VDC test boards must be secured inside an interlocked electrical test cage or enclosure.

#### 4.1 Low Density OFET Test Board

Figure 4.1 shows a labelled diagram of the Low Density OFET Test Board.

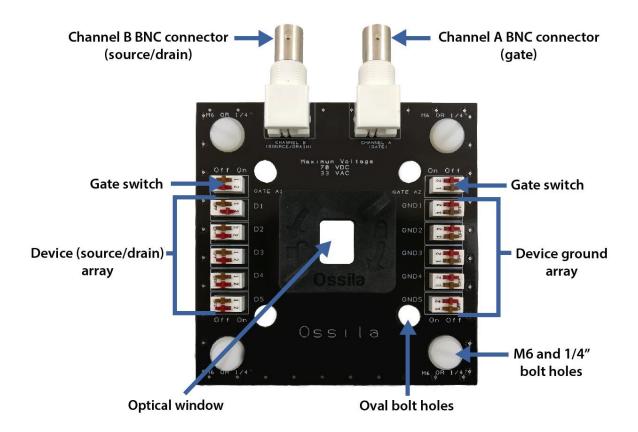


Figure 4.1. Labelled diagram of the Ossila Low Density OFET Test Board (P2013A1).

- 1. Using low-capacitance coaxial cables, connect the gate and source/drain connectors to the gate and drain channels of a multi-channel source-measure unit respectively.
  - I. Alternatively, the test board can be connected to two single channel source-measure units.
- 2. Remove the lid and insert the OFET into the device holder, ensuring the gate and drain contacts are facing down and in contact with the correct pins.
  - I. The gate pins are the pins closest to the BNC connectors.

3. Replace the lid, switch the gate switches to the 'On' position, and ensure that source/drain and ground switches are in the 'Off' position.

**Note:** The switches have two levers on them, when changing the state of a switch both levers should be set to the desired state.

- 4. Set the source/drain and ground switch of the device to measure to the 'On' position.
- 5. Run your measurement.

**Warning:** Do NOT operate the switches or touch the test board while voltage or current is applied to the test board.

#### 4.2 OFET Test Board for High Density OFETs

Figure 4.2 shows a labelled diagram of the OFET Test Board for High Density OFETs.

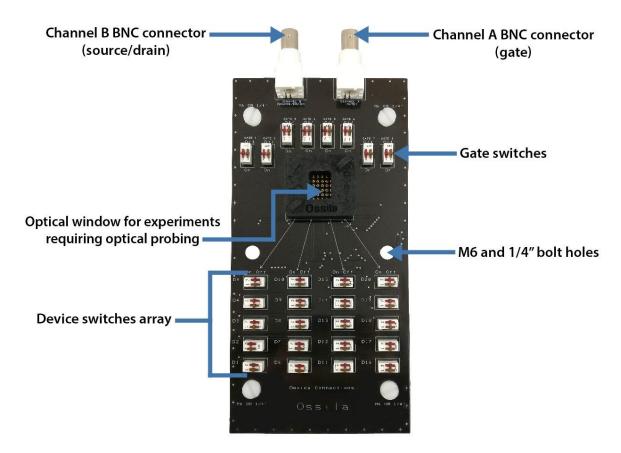


Figure 4.2. Labelled diagram of the Ossila OFET Test Board for High Density OFETs (P2014A1).

1. Using low-capacitance coaxial cables, connect the gate and source/drain connectors to the gate and drain channels of a multi-channel source-measure unit respectively.

www.ossila.com 10 Ossila Limited © 2023

I. Alternatively, the test board can be connected to two single channel sourcemeasure units.

- 2. Remove the lid and insert the OFET into the device holder, ensuring the gate and drain contacts are facing down and in contact with the correct pins.
  - I. The gate pins are the pins closest to the BNC connectors.
- 3. Replace the lid, switch the gate switches to the 'On' position, and ensure that source/drain switches are in the 'Off' position.

**Note:** The switches have two levers on them, when changing the state of a switch both levers should be set to the desired state.

- 4. Set the source/drain switch of the device to measure to the 'On' position.
- 5. Run your measurement.

**Warning:** Do NOT operate the switches or touch the test board while voltage or current is applied to the test board.

www.ossila.com 11 Ossila Limited © 2023

#### 5. Measurement Error and Noise

Measurement accuracy defines how close the measured quantity (current/voltage) is to the actual value. While the accuracy primarily depends on the intrinsic accuracy of the source-measure unit (SMU), several external factors, including setup and measurement settings, can severely degrade the quality of the acquisition. Any test fixture (such as coaxial (BNC) cables, substrate holder etc) introduces additional noise and leakage currents, mainly due to the internal leakage resistances, parasitic capacitances and electromagnetic/electrostatic pickup, making high-precision measurement of low value current/voltage challenging and expensive. To complicate matters, some organic semiconductor compounds require high voltages (±100 V and higher) to yield current of the order of a few hundred nanoampere, a condition that imposes stringent requirements on the insulating properties of the test board, coaxial cable and switches. On the other end of the spectrum, high performance semiconductors with large ON/OFF ratio requires the capability of maintaining high accuracy while acquiring current varying across several measurement ranges of the SMU.

In the following, we will briefly outline some of the more common factors affecting the accuracy and reliability of OFET characterisation.

#### 5.1 High Accuracy Measurements

Let us first introduce a few concepts and definitions that are commonly used when describing the "precision" of a measurement apparatus. For more details, please refer to *Low Level Measurements Handbook*, 6<sup>th</sup> Ed., and Keighley. The content of this paragraph is mainly based on this publication.

Accuracy defines how close the measured value is to the actual value. Generally, a SMU data sheet explicitly states the accuracy as the sum of a constant offset plus a term depending on the measured quantity (% of measured quantity). These values are determined under some precise operational conditions (temperature, time elapsed from the last factory calibration, etc) and, most importantly, depend on the measurement range.

**Sensitivity** is the minimum quantity that the SMU can detect. Again, this depends on the measurement range, temperature, etc.

**Resolution** is the smallest change that the SMU can output or measure. As above, the resolution can depend on the measurement range and is guaranteed if, and only if, certain conditions are met (temperature, calibration etc). For a SMU, the output and input resolution can be different.

**Reproducibility** refers to the capability of a measurement apparatus to yield the same value over time. Ageing, poor maintenance, temperature variations are detrimental to the reproducibility of the measurement outcomes.

www.ossila.com 12 Ossila Limited © 2023

**Uncertainty** is the estimated error that accompanies any measurement. Let us suppose that a SMU is used to estimate the unknown electrical resistance R by applying a voltage V and measuring **both** voltage V and current I across the resistor. If  $\delta V$  and  $\delta I$  are the **independent and random** errors associated to the voltage and current measurements, respectively, the uncertainty of the resistance R = V/I is given by:

$$\delta R = R \sqrt{\left(\frac{\delta V}{V}\right)^2 + \left(\frac{\delta I}{I}\right)^2}$$

In general, (for dependent and/or non-random error):

$$\delta R < R \left( \frac{\delta V}{|V|} + \frac{\delta I}{|I|} \right)$$

The formulas above can be easily generalised to any quantity Q calculated as the product of the **measured** quantities, x, y, l, m..., as in Q = (xyz)/(lmn) [Introduction to error analysis, JR Taylor,  $2^{nd}$  edition.]

#### 5.2 Factors Affecting Measurement Accuracy

Measurement Setting. Generally, a SMU allows the user to set the appropriate measurement range, i.e., the maximum current that the SMU is expected to measure. Currents exceeding the measurement range are not allowed and the SMU will therefore stop increasing the voltage and output a compliance warning. Each measurement range corresponds to a different SMU circuitry optimised to generate and measure signal falling in the chosen range. Usually, the higher the range, the lower the accuracy and the resolution of the SMU. Therefore, for a fixed-range measurement of an I-V sweep spanning several orders of magnitudes, the accuracy of the "OFF" current is limited by the accuracy of the minimum range required to measure the large "ON" current.

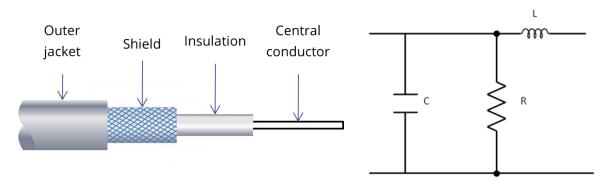
**PLC rejection.** The PLC (Power Line Cycle) is the oscillation of the electrical current supplied through the power grid, which is 50 or 60 Hz depending on the location. Make sure that the SMU is capable of efficiently rejecting the PLC oscillations of the power supply; otherwise, especially for low currents, PLC can manifest itself into an oscillating behaviour of the current/voltage reading.

Settling Time. Any physical system requires a finite time to respond to an external input and reach a new equilibrium state. In the context of current/voltage measurement this transient time is often referred to as settling time, and it depends on the resistivity and capacitive components of the measurement apparatus (SMU, cable and test fixture) and on "speed" of the device under test. The SMU settling time are specified in the SMU User's guide for any measurement range. Note, however, that the SMU can require a longer time to settle if the load current is close to the upper limit of the chosen range.

**Coaxial cable.** Low resistance, low capacitance, shielded coaxial cables are required for fast and accurate measurement, **Figure 5.1**. The cables must be kept away from ES/EM noise sources and

www.ossila.com 13 Ossila Limited © 2023

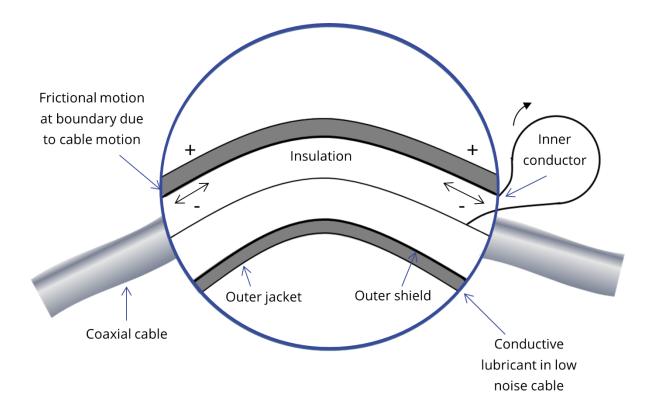
vibrations. Vibrations of the cable can in fact induce carriers in the dielectric due to the rubbing of the dielectric against the external jacket of the cable (triboelectric effect), or as effect of the mechanical stress on the dielectric itself, see **Figure 5.2**. The "noise" induced by vibration-generated charges in the dielectric become non-negligible when measuring low (few nA) currents.



**Figure 5.1.** Right: Coaxial cable: the shield is connected to the LOW (or to the ground) output of the SMU, while the central conductor is connected to the HIGH output. Left side: equivalent circuit of coaxial cable. A coaxial cable can be modelled as a sequence of RLC circuit in series, where Rd, RL and C stand for resistive, inductive and capacitive element of the circuit.

Teflon or PTFE insulated coaxial cables are ideal for measuring currents less than 10<sup>-14</sup> Amp. Cables with polyethylene insulation also have low leakage resistance and will give good performance. In any case, the coaxial cable should be chosen to have low capacitance per unit length and kept as short as possible.

www.ossila.com 14 Ossila Limited © 2023



**Figure 5.2.** Vibration and mechanical stress exerted on the dielectric of a coaxial cable can induce charges generated at the Jacket/Dielectric interface (triboelectric effect), or inside the dielectric itself (piezoelectric current). Negligible for high current measurement, these spurious currents can degrade the accuracy of low-level current acquisitions.

Metal/Metal Heterojunction. Any temperature difference between two parts of a conductive material results in a potential drop across the material itself (Seebeck effect). The Seebeck effect is quantified by the Seebeck coefficient, which has the unit of  $\mu V/^{\circ}C$  and expresses the potential drop for a 1 °C of temperature difference. The coefficient depends on the type of metal(s) and on the temperature of the conductor itself. Typical values range from few  $\mu V/^{\circ}C$  for Al, Au and Cu, to hundreds of  $\mu V/^{\circ}C$  for Si. For standard OFET characterisation with driving voltage larger than 1 V, the error introduced by Seebeck is negligible. On the contrary, for low-voltage driving potential (<0.1 V), the Seebeck effect can affect the measurement accuracy, especially for study of the temperature-dependence semiconductor properties such as the field-effect mobility. Such low-voltage measurements are common for graphene-based devices.

Temperature and Humidity. The precision of the SMU is stated with respect to a specific calibration temperature; to this respect, the User is advised to carefully read the SMU manual and familiarise with the concept of temperature coefficient for current-voltage sweep. In general, if the SMU temperature is more than five degrees centigrade lower or higher than the factory specifications, the User should correct the reading using the appropriate equation and temperature coefficients as stated in the SMU's user manual. In addition, the temperature effects are responsible for variations in the resistance of any resistor R used in the measurement setup. Humidity can increase spurious current by reducing the dielectric capacitance and increasing leakage resistance.

www.ossila.com 15 Ossila Limited © 2023

**Ground Loop.** A ground loop is an unwanted potential difference between two points of the measurement set that are supposed to be at the same potential. For example, if the ground of the DUT and the ground of the SMU are not the same, a ground loop will exist between the DUT and the SMU. A ground loop can also be found between two SMUs grounded to the "building" ground. Usually, there is a small difference of potential between any power sockets, therefore two SMUs grounded to two different sockets can present a ground loop. This potential difference generates a spurious current, which in turn introduces an error in the measurement. For OFET measurements, make sure that the ground of the drain and the ground of the gate are at the same potential. On the probe station and the manuals board, both the gate and drain are grounded through the ground plane, thus minimising any ground loops. However, if you use long BNC cables it is good practice to connect the ground (low) together. In addition, SMU with an internal ground (LOW output) independent of the building ground minimise ground loop.

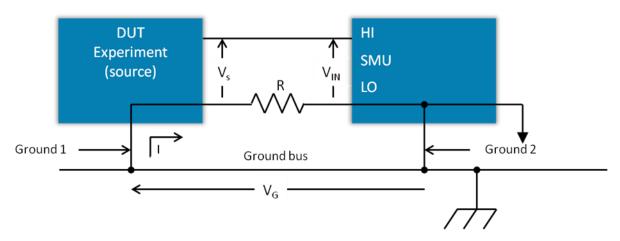


Figure 5.3. Ground loop: VG is the potential drop between the DUT and the SMU.

**Electrostatic Interference and RF.** A charged body (such as human being or charged plastic object) can interfere with the measurement apparatus and introduce errors of the order of nA, in particularly when carrying out a high resistance measurement as the externally-induced charge does not dissipate quickly. These errors are usually negligible for current in the range of μA or larger; however, they can potentially disrupt the measurement of the low OFF transistor currents, where the simple movement of a human hand close to the DUT can result in detectable "spikes". Although the board is shielded using a double ground plane, the pins are exposed. It is therefore good practice to position the DUT at least 1 meter away from electrically charged body. In addition to DC electrostatic noise, AC noise (due to PLC frequency) and RF noise can degrade the accuracy of low current/voltage measurement. The double ground plane is designed to reject EMC noise; however, the source of intense AC noise such as pumps and mobile phone screens must be kept (at least) 1 meter away from SMU, coaxial cables and DUT.

www.ossila.com 16 Ossila Limited © 2023

#### 5.3 Test set-up conditions.

• Care must be taken to ensure that the bottom of the board is well isolated from any conductive surface, both for safety reason and to minimize leakage currents.

- Do NOT operate the switches or touch the test boards when a voltage or current is applied.
- Do NOT apply voltages above ±50 VAC or ±70 VDC unless the test board is secured inside an interlocked electrical test cage or enclosure.
- The absolute maximum values to be applied to the test board are ±100 V and ±100 mA.

www.ossila.com 17 Ossila Limited © 2023

#### 6. Related Products



# Silicon Oxide Substrates and Wafers

Silicon substrates designed for use as FET substrates.

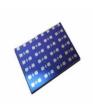
Product codes: S146 / S147 / S148



#### **Flat Tip Tweezers**

Provides a good substrate grip without scratching.

Product code: C121



#### Platinum OFET Test Chips, High Density

Prefabricated FET test chips, for easy and rapid characterisation.

Product codes: S403 / S404



# ITO Glass Substrates, 20 x 15 mm, OFET and Sensing

Pre-patterned ITO substrates for rapid fabrication and characterisation of OFETs.

Product code: S161 / S162



# **Evaporation Stack for OFETs, Low Density**

Evaporation stack for thermal evaporation of OFETS. For use with low-density deposition masks.

Product code: E281



# Source-Drain Deposition Mask, Low Density

Shadow masks for deposition of source drain contacts for low-density OFETs.

Product codes: E291 / E292



# **Evaporation Stack for OFETs, High Density**

Evaporation stack for thermal evaporation of OFETS. For use with high-density deposition masks.

Product code: E312



# Source-Drain Deposition Mask, High Density

Shadow masks for deposition of source drain contacts for high-density OFETs.

Product code: E321 / E322 / E323